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APPENDIX

APPENDIX A

THE CALCULATION OF THE MOLE RATIO BETWEEN ANACARDIC ACID AND FORMALDEHYDE AND SODIUM HYDROXIDE

molecular weight of formaldehyde = 30.03 g/mol molecular weight of sodium hydroxide = 40.01 g/mol

a. averge molecular weight of anacardic acid ($C_{22}H_{30-36}O_3$)

= (348+346+344+342)/4

= 345 g/mol

% anacardic acid in CNSL = 82%

anacardic acid in 200 g CNSL = (82x200)/100 g

= 164 g

= 164/345 mole

= 0.475 mole

formaldehyde in 40 g of 37% formalin = (37x40)/100 g

= (37x40)/(100x30.03) mole

= 0.493 mole

mole formaldehyde : mole anacardic = 0.493/0.475

= 1.038

b. 2 g sodium hydroxide = 2/40.01 mole

= 0.050 mole

mole sodium hydroxide : mole anacardic = 0.050/0.48

= 0.104

APPENDIX B

TERMINOLOGY OF ADHESIVES [12,13]

adherend, n

a body held to another body by an adhesive.

adhesion, n

the state of being held together by means of an interlayer of adhesive between adherend interfaces: the attachment of two surfaces by interfacial forces, chemical bonding forces, interlocking action, or combinations of these.

adhesive, n

a material that binds other material together by surface attachment.

adhesive assembly, n

a group of materials or parts, including adhesive, placed together for bonding or which has been bonded together (See also assembly adhesive).

adhesive, cold setting

an adhesive which sets at temperature below $20^{\rm o}{\rm C}$ (68°F). adhesive, hot setting

an adhesive with a setting temperature of $100^{\rm O}{\rm C}$ ($212^{\rm O}{\rm F}$) or more.

adhesive, intermadiate temperature setting

an adhesive which sets in the temperature range $31-99^{\circ}$ C $(87-211^{\circ}F)$.

adhesive, room temperature setting

an adhesive which sets in the temperature range $20-30^{\circ}$ c (68-86°F).

adhesive, warm setting

an intermediate temperature setting adhesive (31-99°c). assembly adhesive, n

an adhesive that can be used for bonding together, such as in the manufacture of a boat, airplane, furniture, and the like.

assembly time, n

the time interval between applying the adhesive on the substrate and the application of pressure, or heat, or both, to the assembly.

closed assembly time, n

the time interval between the closing together of substrates after adhesive has been applied, and the application of pressure, heat, or both to the assembly.

opened assembly time, n

the time interval between applying adhesive on the substrates and closing them together before bonding.

cold pressing

a bonding operation in which an assembly is subjected to pressure without the application of heat.

dry, v

to change the physical state of an adhesive on an adherend by the loss of solvent by evaporation or absorption, or both.

drying temperature, n

the temperature to which an adhesive on an adherend or in an assembly or the assembly itself is subjected to dry the adhesive.

drying time, n

the period of time during which an adhesive on an adherend or an assembly is allowed to dry with or without the application of heat or pressure, or both.

hot pressing

the curing of thermosets by heat and pressure application to a bonded assembly, e.g. plywood and laminate manufacture or production of multi-layer printed circuit boards.

laminate, n

a product formed by honding together two or more layers of material or materials.

laminate, v

to unite layers of material with adhesive.

lamination, n

- 1) the process of preparing a laminate.
- 2) any layer in a laminate.

spread, n

the quantity of adhesive per unit joint area applied to an adherend, usually expressed in pounds of adhesive per thousand aquare feet of joint area.

double spread, n

application of adhesive to both adherends of a joint.

single spread, n

wetting

application of adhesive to only one adherend of a joint.

a surface is said to be completely wet by a liquid if the contact angle is zero and incompletly wet if is a finite angle. Surfaces are commonly.

APPENDIX C

FORMULATION OF COMPOUNDED NATURAL RUBBER AND ITS RHEOGRAPH

Table C.1 Formulation of compounded natural rubber [40]

Compositions	Gradients
NR	60
Reclaim	80
Peptiser	1
Stearic acid	1
Pine tar	2
Antioxidant	1
Zine oxide	5
Black	30
MBTS	1
TET	0.1
Sulphur	2
total	183.1

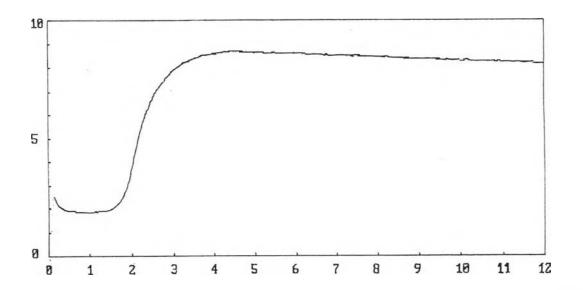


Figure C.1 Reograph of compounded natural rubber, $T_{90} = 10 \text{ min}$ (Union Commercial Development Co., Ltd.)

Temperature setting	150 °C
Time range	15 min
Torque	41.0 in-lb
Torgue range	50
Vibration angle	1

Miss Wimonlak Noobutr was born on March 8, 1967 in Bangkok. She recieved her Bachelor's Degree of Science in Chemistry from Department of Chemistry, Faculty of Science, Kasetsart University in 1989. She began her Master study at The Petroleum and Petrochemical College, Chulalongkorn University, in 1989 and completed the program in 1992.

